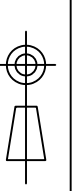


PCB LAYOUT

- SPECIFICATIONS
- 1、Current Rating: 1A AC, DC
  - 2、Voltage Rating: 50V AC, DC
  - 3、Temperature Range: -25°C~+85°C
  - 4、Contact Resistance: 20mΩ Max
  - 5、Insulation Resistance: 100MΩ Min
  - 6、Withstanding Voltage: 500V AC/minute
  - 7、Material: Wafer LCP, UL94V-0
- PIN Phosphoric bronze Tin-plated  
Solder tad Phosphoric bronze Tin-plated

P/N	mm		
	A	B	C
SH1.0-02AB	1.00	4.00	3.20
SH1.0-03AB	2.00	5.00	4.20
SH1.0-04AB	3.00	6.00	5.20
SH1.0-05AB	4.00	7.00	6.20
SH1.0-06AB	5.00	8.00	7.20
SH1.0-07AB	6.00	9.00	8.20
SH1.0-08AB	7.00	10.00	9.20
SH1.0-09AB	8.00	11.00	10.20
SH1.0-10AB	9.00	12.00	11.20
SH1.0-11AB	10.00	13.00	12.20
SH1.0-12AB	11.00	14.00	13.20
SH1.0-20AB	19.00	22.00	21.20



单位  
UNIT

mm

比例  
SCALE

X.±0.5 X\*±

.X±0.30 X\*±

.XX±0.20 .XX\*±

.XXX±0.003 .XXX\*±

核准: APPROVED BY	版本: A0	产品名称 Production name	深圳市泰华电子有限公司 TaIHua Electronics Co., Ltd
审核: CHECKED BY	页次: 1/1	产品料号 Product No	SH1.0 立贴 WAFER SMT TYPE
制图: DRAWN BY	日期: 2022.10.24	客户料号 Client No	TH-SH1.0-NAB